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## Low k Dielectic Materials

Guest Editor:

## Prof. Dr. Rajendra Singh

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Deadline for manuscript submissions:

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## Message from the Guest Editor

Dear Colleagues,

For Low k dielectric materials, the value of dielectric constant is less than the dielectric constant of silicon dioxide. Such materials are of great importance for multilevel interconnections of nanoelectronics and radio frequency (RF) devices and circuits. Other applications include optoelectronics, 3-D integrated circuits. microelectromechanical systems (MEMS). nanoelectromechanical (NEMS), sensors and detectors and packaging of various types of devices and circuits. All topics related to synthesis, and properties of low-k dielectrics, various processing techniques, process integration, performance and reliability of low-K based devices, circuits and systems are of interest for this journal issue.

Dr. Rajendra Singh Guest Editor













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## **Editor-in-Chief**

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# **Message from the Editor-in-Chief**

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